502506870 09/24/2013

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Chen-Chung Lai	06/26/2013
Kang-Min Kuo	06/26/2013
Yen-Ming Peng	06/26/2013
Gwo-Chyuan Kuoh	06/26/2013
Han-Wei Yang	06/26/2013
Yi-Ruei Lin	06/26/2013
Chin-Chia Chang	06/26/2013
Ying-Chieh Liao	06/26/2013
Che-Chia Hsu	06/26/2013
Bor-Zen Tien	06/26/2013

RECEIVING PARTY DATA

Name:	Taiwan Semiconductor Manufacturing Co., LTD	
Street Address:	No.8, Li-Hsin Rd.6, Science-Based Industrial Park	
City:	Hsinchu	
State/Country:	TAIWAN	
Postal Code:	300	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13930161

CORRESPONDENCE DATA

Fax Number: 4804645692

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

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PATENT REEL: 031267 FRAME: 0905 OP \$40.00 13930161

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ATTORNEY DOCKET NUMBER:	28503-004
NAME OF SUBMITTER:	Steven J. Laureanti
Signature:	/Steven J. Laureanti/
Date:	09/24/2013
Total Attachments: 3 source=004-executed-Assignment#page1.tif source=004-executed-Assignment#page2.tif source=004-executed-Assignment#page3.tif	

PATENT REEL: 031267 FRAME: 0906

ASSIGNMENT

This assignment agreement is applicable to an invention entitled (Invention Title)				
SEMICONDUCTOR DEVICE WITH SELF-PROTECTING FUSE AND METHOD OF				
FABRICATING THE SAME				
The PATENT RIGHTS referred to in this agreement are:				
(check one) a patent application for this invention, executed by the ASSIGNOR(S)				
concurrently with this assignment.				
XU.S. patent application Serial No.13/930.161, filed on June 28, 2013				
☐a U.S. patent application based on PCT International Application				
Nofiled on (date)(U.S. patent application				
Serial No, if known).				
U.S. patent No, issued				
The PATENT RIGHTS also include all divisions, reissues, continuations and extensions of				
the patents and patent applications identified above.				
The PATENT RIGHTS assigned under this agreement are:				
(check one) ⊠U.S. patent rights only.				
Worldwide patent rights. In this case, the assignee shall have the right to				
claim the benefit of the filing date of any U.S. or foreign patent application				
for this invention.				
The ASSIGNOR(S) referred to in this agreement is (or are) the inventor(s) whose signatures				
appear on page 2 of this Assignment and any Supplemental Sheet(s).				
The ASSIGNEE referred to in this agreement is:				
(Name of Assignee) TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.				
(Address) NO.8, LI-HSIN RD.6, SCIENCE-BASED INDUSTRIAL PARK, HSINCHU,				
TAIWAN 300, R.O.C.				
The ASSIGNEE is:				
(check one) An individual.				
☐A Partnership.				
(other)				

The ASSIGNOR(S), in consideration of \$10.00 paid by the ASSIGNEE, and other good and valuable consideration, receipt of which is acknowledged, hereby assign(s) the following rights to the ASSIGNEE, its successors and assigns:

the full and exclusive right to the invention;

the entire right, title and interest in and to the PATENT RIGHTS;

the right to sue and recover for any past infringement; and

the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable provisions, based on any earlier patent applications for this invention.

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THIS IS PAGE 2 OF AN ASSIGNMENT FROM THE INVENTOR(S) TO ASSIGNEE: TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. INVENTION TITLE: SEMICONDUCTOR DEVICE WITH SELF-PROTECTING FUSE AND METHOD OF FABRICATING THE SAME

As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Commissioner of Patents and Trademark to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any fact known to the ASSIGNOR(S) with respect to said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause and all Letter Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

The ASSIGNOR(S) authorize(s) the attorneys and agents who have the power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been executed.

Chen-Chung LAI	Chen-Chunge LAZ	2013/6/26
Name of sole or first inventor	Signature	Date
Kang-Min KUO	Cay - Non lan-	2117/6/56
Name of second inventor, if any	Signature	Date
Yen-Ming PENG	Ven - Ming Peng Signature	>013/6/26
Name of third inventor, if any	Signature V	Date
Gwo-Chyuan KUOH	Gwo-Chyuan Euch	2013/6/26
Name of fourth inventor, if any	Signature	Date
Han-Wei YANG	Han-Wir Yang	2013/b/No
Name of fifth inventor, if any	Han-Wi Yang Signature	Date
Yi-Ruei LIN	Yi frei LIN	2013/6/26
Name of sixth inventor, if any	Signature	Date
Chin-Chia CHANG	Chin-Chia Chang	2013/6/26
Name of seventh inventor, if any	Signature 0	Date

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Ying-Chieh LIAO

Name of eighth inventor, if any

Che-Chia HSU

Name of ninth inventor, if any

Bor-Zen TIEN

Name of tenth inventor, if any

2013 8/26 Date

Che-cha Hou

Signature

Signature

2013/6/56

Date

PATENT REEL: 031267 FRAME: 0909

RECORDED: 09/24/2013